Features

General

- 1 -output programmable clock generator
- High jitter performance
- Working temperature: -40°C ~ 85°C
- Power supply: 1.8V to 3.3V
- Low power consumption
  - <100mW (1.8V with 100MHz LP-HCSL outputs)
- Input reference source option
  - SYKG1011E: external crystal or clock input
  - SYKG1011Q5: internal crystal

Input Reference Clock

- Single input source
  - Crystal input source
    - Internal crystal: 50MHz
    - External crystal: 8MHz ~ 50MHz
  - Clock input source
    - Frequency range: 1.22MHz ~ 250MHz
    - Acceptable input duty cycle: 40 ~ 60%

Output Clock

- 1 differential-pair outputs
- Output frequency range: 1MHz ~ 333.33MHz
- SYNK-developed LP-HCSL for high jitter performance and low power
- Support LVPECL and CML logic with easy AC coupling
- 1 LVCMOS reference clock outputs
- Support all three PCIe clocking architectures
  - Common Clocked (CC)
  - Independent Reference without spread spectrum (SRnS)
  - Independent Reference with spread spectrum (SRIS)
- Optional individual SSC setting for all output clocks; feedback fractional divider used by SSC for better jitter performance
- Programmable output impedance: 85Ω/100Ω or off Control

Control

- Three control modes selectable at power-on stage: I2C mode, OTP mode, PIN mode
- Output clock dynamical control by multi-function pins
- Support up to 4 On-chip OTP configurations
- Four programmable I2C addresses: D0, D2, D4, D6

Package

- 2.5mm x 2.5mm x 1.1mm,0.5mm pitch, 12-pin LGA
- Package MSL: Level-3-260C

Key Specifications

- 250fs RMS 12kHz ~ 20MHz typical phase jitter at 100MHz
- 230fs RMS 12kHz ~ 20MHz typical phase jitter at 156.25MHz
- FFB PCIe Gen5 jitter (CC) typical 30fs RMS
- FOD PCIe Gen5 jitter (CC) typical 98fs RMS
- FFB PCIe Gen6 jitter (CC) typical 20fs RMS
- FOD PCIe Gen6 jitter (CC) typical 66fs RMS

Applications

- High-performance Computing (HPC)
- Storage, like SSD
- Ethernet
- Fiber Optic Modules
- NVLink

General Description

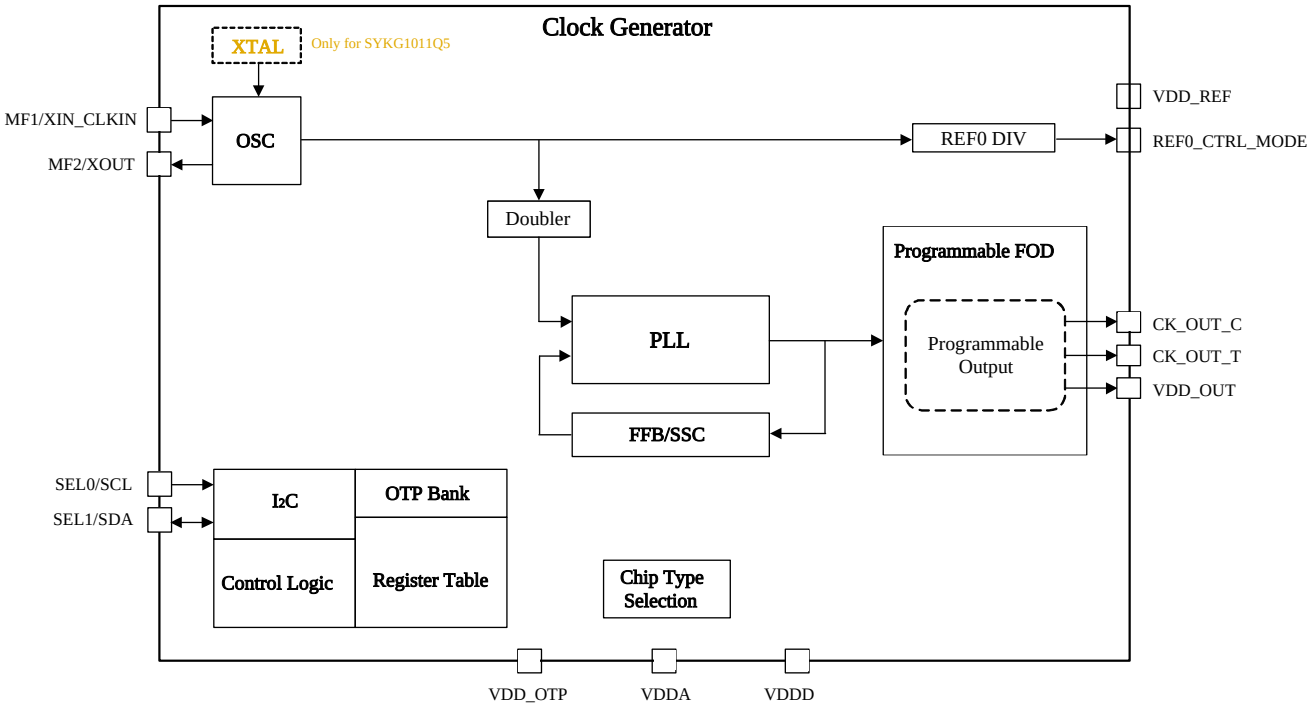
SYKG1011E/Q5 is a Clock Generator with one input reference clock, one programmable output pairs plus one LVCMOS reference outputs.

The chip utilizes SYNK ’s advanced IO technology to generate a wide range of frequencies with excellent jitter performance for low phase noise spread-spectrum applications such as PCIe. It can source multiple 100MHz PCIe clock outputs. All differential clock outputs are compliant to PCIe Gen1/2/3/4/5/6 common clock and separate reference clock architecture specifications.

This chip supports the initialization through on-chip One-Time Programmable (OTP) configurations. These chip configuration can be partly or fully modified in working state according to the current control mode decided by a strapping pin at power-up stage, which easily realizes software selection of the desired configuration. Four programmable I2C addresses are available, allowing easy I2C access to multiple components.

Functional Block Diagram

Figure 1. SYKG1011E/Q5 Block Diagram



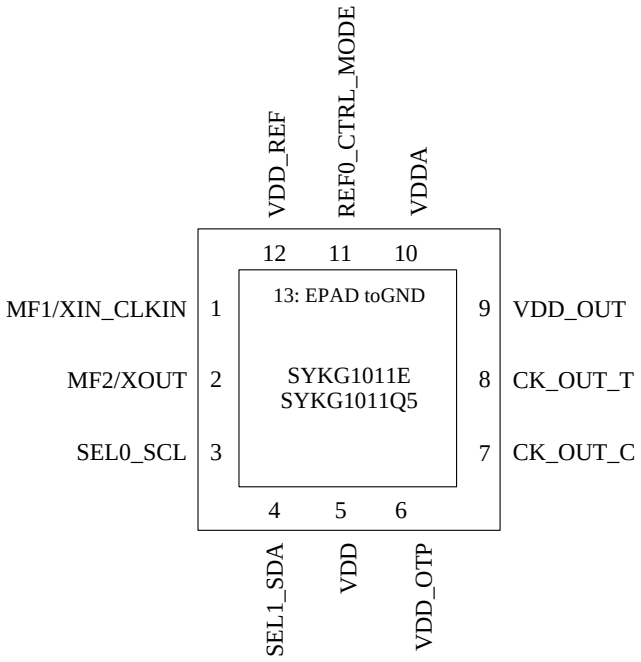
Notes:

1. FFB: Fraction Feedback Divider
   FOD: Fraction Output Divider
   IN DIV: Input Divider
   OTP: One-Time Programmable
   PLL: Phase Locked Loop
   SSC: Spread Spectrum Clocking
   XTAL: Crystal

1 Pin Information

1.1 Pin Assignment

Figure 2. 12-LGA Pin Assignment, 2.5mm x 2.5mm x 1.1mm, 0.5mm Pitch (Top view)



1.2 Pin Description

Table 1. Pin Description for SYKG1011E/Q5(12-LGA) (Sheet 1 of 2)

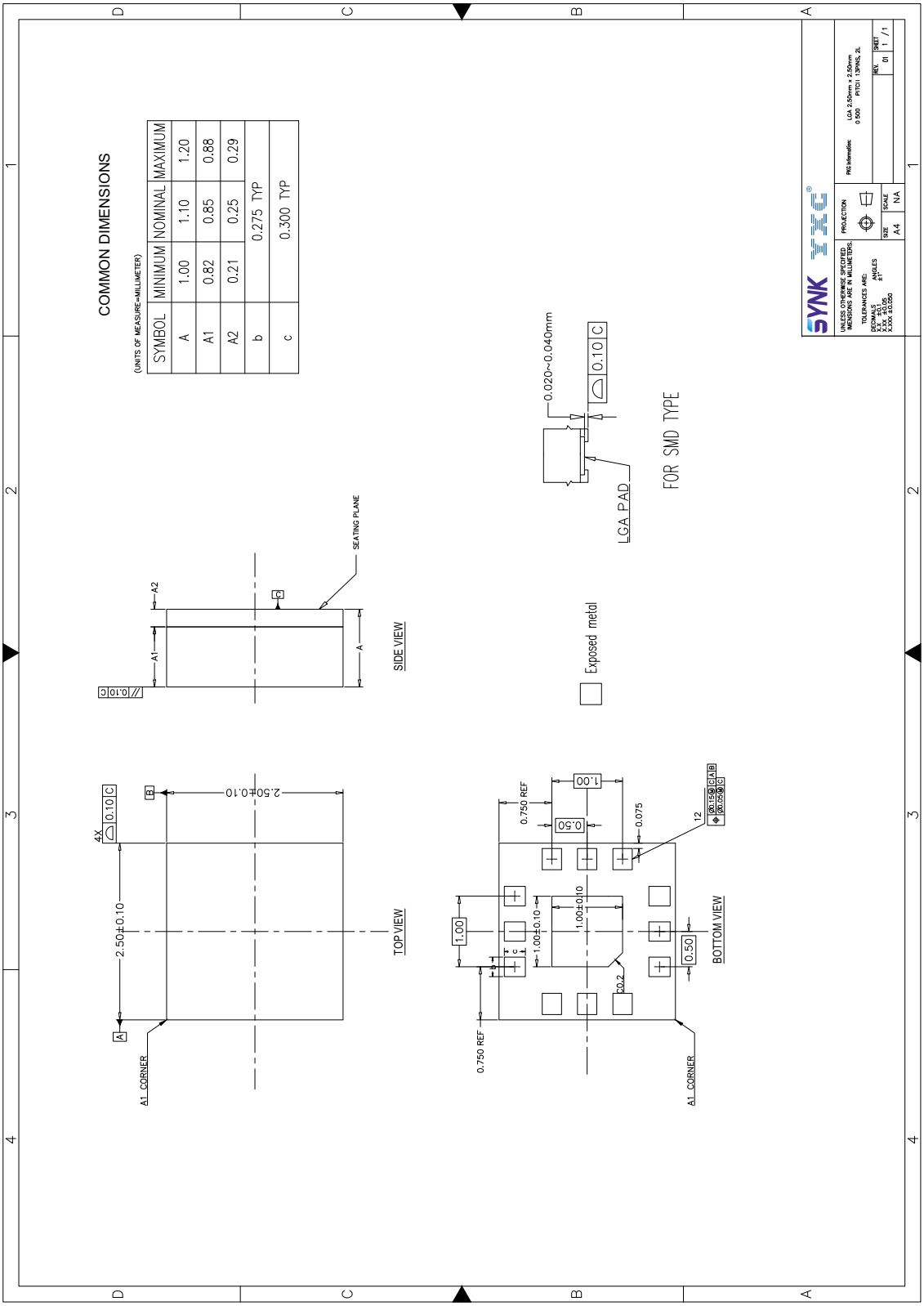
Pin NO.	Pin Name	Type	Description
1	MF1/XIN_CLKIN	Input	Crystal input or reference clock input or multi-function pin.
2	MF2/XOUT	Input/Output	Crystal output or multi-function pin.
3	SEL0_SCL	Input	Tri-state logic clock pin with 120kΩ internal pull-up and pull-down. Be used as LSB of control mode selection or I2C SCL.
4	SEL1_SDA	Input/Output	Tri-state logic datapin with 120kΩ internal pull-up and pull-down.Be used as M SB of control mode selection or I2C SDA.
5	VDDD	Power	Digital power.Connect to 1.8V,2.5V,3.3V.
6	VDD_OTP	Power	Voltage for OTP programming, 1.8V±10%. For Read operation, this pin can be connected to VDDD if V_{DDD} is lower than 2.5V. This pin must be tied to ground or floating if the V_{DDD} is greater than 2.5V. It is recommended to connect VDD_OTP to ground or leave VDD_OTP floating, no matter what level V_{DDD} is.
7	CK_OUT_C	Output	Complementary OutputClock.

Table 1. Pin Description for SYKG1011E/Q5(12-LGA) (Sheet 2 of 2)

PinNO.	PinName	Type	Description
8	CK_OUT_T	Output	Output Clock0.
9	VDD_OUT	Power	Power supply for CK_OUT
10	VDDA	Power	Analog power.Connect to same voltage as V_{DDD} with suitable filtering.
11	REF0_CTRL_MODE	StrappingPin	Chip configuration model selection and LVCMOS clock output. Tri-state logic in put pin. At power-up, the state of this pin is latched to select the functionality of several hardware pins. After power-up, this pin acts as one LVCMOS reference output with the output frequency same as input reference or scale down to 1/64 at most.
12	VDD_REF	Power	Power supply for REF output and the internal XOUT. Nominal voltages are 1.8V , 2.5V and 3.3V.
13	EPAD	GND	Connect to ground.

2 Mechanical Package Data

Figure 3. 12-LGA Package Outline (2.5mm x 2.5mm x 1.10mm, 0.5mm Pitch)



3 Ordering Information

Part Number	Package	Temperature	Crystal	Packing
SYKG1011E--XX	2.5mm x 2.5mm x 1.1mm, 0.5mm pitch 12-LGA; MSL Level-3-260C	-40~+85°C	External	Tray
SYKG1011E--XX-T				Tape & Reel
SYKG1011Q5--XX		-40~+85°C	50MHz Internal	Tray
SYKG1011Q5-XX-T				Tape & Reel

This document is a brief product specification sheet that outlines only the basic features. For detailed electrical specifications, please contact https://www.yxcxtal.com to request the complete version of the specification sheet.